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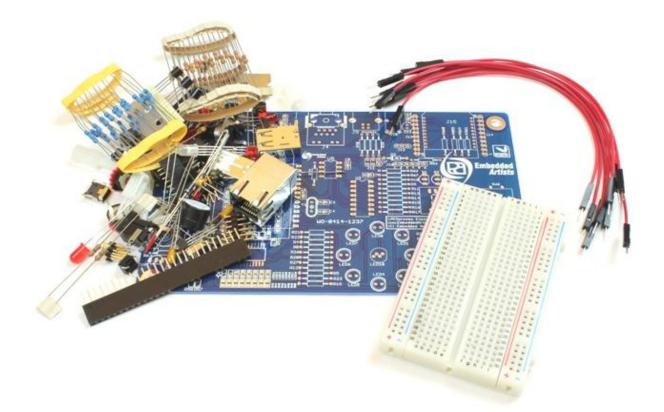
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LPCXpresso Experiment Kit - User's Guide

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LPCXpresso Experiment Kit User's Guide



Learn embedded programming with NXP's LPC1000 family of Cortex-M0/M3 microcontrollers!



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Revision	Date	Description
PA1	2012-07-16	Work in progress.
PA2	2013-01-14	Work in progress.
PA3	2013-01-25	First version to be released. All experiments are still not complete.
PA4	2013-01-29	Minor corrections/clarifications.
PA5	2013-02-25	Completed section 7.9 - 7.10.
PA6	2013-03-19	Completed section 7.11-7.14. Cleanup in variable declarations in code fragments. Added instructions about creating driver structured source code.
PA7	2013-04-08	Completed section 7.15. Changed all code fragments to use predefined typedefs for variable declaration. Minor corrections.

2 Introduction

Thank you for buying Embedded Artists' *LPCXpresso Experiment Kit* designed to work with NXP's ARM Cortex-M0/M3 LPCXpresso target boards.

This document is a User's Guide that describes the *LPCXpresso Experiment Kit* that describes hardware as well as software related to the kit.

2.1 Features

The kit has been created as a guided tour to learn embedded programming with NXP's LPC1000 microcontroller family with Cortex-M0/M3 cores from ARM. The experiments can be performed on a breadboard for maximum flexibility and ease of use. It is also possible to solder the components to a printed circuit board (pcb) and learn soldering at the same time.

Components included in the kit are:

- 8x LEDs
- 2x Trimming potentiometers
- 7x push-buttons
- RGB-LED
- Light sensor (analog)
- Temperature sensor (analog)
- 7-segment LED, dual digit
- E2PROM with SPI interface
- Temperature sensor with I2C interface (only for pcb mounting)
- Piezo buzzer
- Rotary quadrature encoder (only for pcb mounting)
- Shift register
- I2C ports expander (PCA9532, only for pcb mounting)
- USB Host connector (only for pcb mounting)
- USB Device connector (only for pcb mounting)
- RJ45 connector for Ethernet (only for pcb mounting)
- 14-pos serial expansion connector, for interface to for example graphical displays
- 3x servo connectors. Note that servos are not included.
- XBee[™] compatible socket (for ZigBee and WiFi modules). Note that RF module is not included.
- LPC1114 in DIL28 package, with 12MHz crystal and SWD connector (only for pcb mounting)
- Local +3.3V voltage regulator
- Miscellaneous resistors, capacitors, transistors and connectors
- Breadboard with cables
- Naked PCB

2.2 ESD Precaution

Please note that the *LPCXpresso Experiment Kit* come without any case/box and all components are exposed for finger touches – and therefore extra attention must be paid to ESD (electrostatic discharge) precaution.

Always work with the LPCXpresso Experiment Kit in a place with proper ESD protection.

Avoiding electrostatic discharge is all about having the same electric potential and to avoid building up charges between different areas where you work. This



is easily accomplished by having a conductive surface on your workbench and connecting yourself with this surface via a wrist wrap.

Note that Embedded Artists does not replace boards that have been damaged by ESD.

2.3 General Handling Care

Handle the *LPCXpresso Experiment Kit* and all included components with care. The board is not mounted in a protective case/box and is not designed for rough physical handling. Connectors and components can wear out after excessive use. The LPCXpresso Experiment Kit is designed for prototyping use, and not for integration into an end-product.

2.4 Code Read Protection

The LPC1000 family has a Code Read Protection function (specifically CRP3, see datasheet for details) that, if enabled, will make the microcontroller impossible to reprogram (unless the user program has implemented such functionality).

Note that Embedded Artists does not replace LPC1000 family chip where the chip has CRP3 enabled. It's the user's responsibility to not invoke this mode by accident.

2.5 CE Assessment

The LPCXpresso Experiment Kit is CE marked. See separate CE Declaration of Conformity document.

The *LPCXpresso Experiment Kit* is a class A product. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

EMC emission test has been performed on the *LPCXpresso Experiment Kit*. Standard interfaces like Ethernet, USB, serial have been in use. Connecting other devices to the product via the general expansion connectors may alter EMC emission. It is the user's responsibility to make sure EMC emission limits are not exceeded when connecting other devices to the general expansion connectors of the *LPCXpresso Experiment Kit*.

Due to the nature of the *LPCXpresso Experiment Kit* – an evaluation board not for integration into an end-product – fast transient immunity tests and conducted radio-frequency immunity tests have not been executed. Externally connected cables are assumed to be less than 3 meters. The general expansion connectors where internal signals are made available do not have any other ESD protection than from the chip themselves. Observe ESD precaution.

2.6 Other Products from Embedded Artists

Embedded Artists have a broad range of LPC1000/2000/3000/4000 based boards that are very low cost and developed for prototyping / development as well as for OEM applications. Modifications for OEM applications can be done easily, even for modest production volumes. Contact Embedded Artists for further information about design and production services.

2.6.1 Design and Production Services

Embedded Artists provide design services for custom designs, either completely new or modification to existing boards. Specific peripherals and I/O can be added easily to different designs, for example,

communication interfaces, specific analog or digital I/O, and power supplies. Embedded Artists has a broad, and long, experience in designing industrial electronics in general and with NXP's LPC1000/2000/3000/4000 microcontroller families in specific. Our competence also includes wireless and wired communication for embedded systems. For example IEEE802.11b/g (WLAN), Bluetooth[™], ZigBee[™], ISM RF, Ethernet, CAN, RS485, and Fieldbuses.

2.6.2 OEM / Evaluation / QuickStart Boards and Kits

Visit Embedded Artists' home page, www.EmbeddedArtists.com, for information about other OEM / *Evaluation / QuickStart* boards / kits or contact your local distributor.

3 LPCXpresso Experiment Kit

The LPCXpresso Experiment Kit has been created as a guided tour to learn embedded programming with NXP's LPC1000 microcontroller family with Cortex-M0/M3 cores from ARM. The experiments can be performed on a breadboard for maximum flexibility and ease of use. It is also possible to solder the components to a printed circuit board (pcb) and learn soldering at the same time. Figure 1 illustrates the two ways of working with the kit. To the left, all components have been soldered to the pcb and the LPCXpresso board is mounted in a socket on the pcb. To the right, a bread board is used and wires connect directly between the bread board and the LPCXpresso board. Note that the LPCXpresso board is not included in the normal LPCXpresso Experiment Kit.

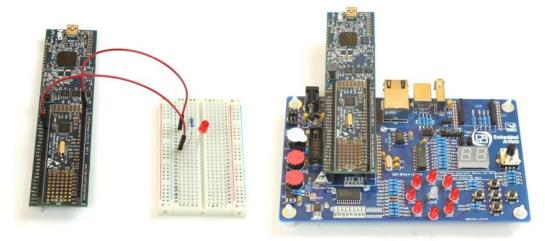


Figure 1 – Breadboard Experiments and Working with PCB

The kit is based on the LPC1000 LPCXpresso evaluation boards, which is a whole family of boards. **All experiments are based around the LPCXpresso LPC1115/1114 board** unless otherwise noted. The term *LPC111x* will be used for the rest of the document to indicate both LPC1115 and LPC1114. Some of the experiments (Ethernet and USB related) are based on the LPCXpresso LPC1769 board. It is also possible to work with the LPC1114 in DIL28 package, which is a breadboard friendly package.

The suggested work flow is as follows: first start with performing the experiments with a group of components on the bread board together with an LPCXpresso board. When done with the experiments, solder the components to the pcb. Continue with the next group of components. Some components only work on the pcb, simply because they do not fit into the bread board. Perform the experiments related to these components when they have been soldered to the pcb. There are of course other ways of working, for example soldering all components to the pcb at the end of all experiments or work separately with the LPC1114 in DIL28 package instead of an LPCXpresso board. Note that in the latter case, an LPC-Link[™] is needed to program the LPC1114. The LPC-Link is the "debugger half" of an LPCXpresso board.

The LPC111x is built around a Cortex-M0[™] core from ARM and the LPC1769 has a Cortex-M3[™] core. Most things addressed with the experiments are general to all microcontrollers and embedded systems programming in general. The details are however slightly different between different microcontrollers, for example the different functionality and registers tin the on-chip peripherals.

After having worked with the *LPCXpresso Experiment Kit*, and completed the experiments, you will have gained several competences at basic level:

- embedded programming
- professional debugging techniques
- microcontrollers and how they interact with their environment

- electronic design in general
- how to work with a breadboard
- how to solder

It is assumed that you know how to program in C. You do not have to be an experienced user but at least know about the basics. If not, the Internet is full of ANSI-C tutorials. A good start can be https://en.wikibooks.org/wiki/C_Programming.

The program development environment (also called Integrated Development Environment – IDE, for short) used is the **LPCXpresso IDE**, which is a Eclipse-based IDE, a GNU C-compiler, linker, libraries and an enhanced GDB debugger. For more information see [5].

3.1 Embedded Systems Programming

Embedded systems programming is truly multi-disciplinary. An engineer must master many knowledge areas in order to do a good job. There are at least five of these areas:

- General programming knowledge

 (C, algorithms and data structures, understanding the development environment, debugging techniques, safe programming styles, version handling, documentation, etc.)
- Knowledge about programming close to the hardware / Firmware programming (interrupts, memory mapped accesses for control registers, types of memories, etc.)
- Knowledge about the specific hardware (details about microcontroller used incl. all peripherals, I/O, communication interfaces, etc.)
- Application programming (real-time operating systems, program frameworks, user interfaces, drivers, logging, field updates, boot loader structures, factory calibration/settings, configuration management, communication protocols, graphical programming, security, etc.)
- 5) Last but not least, the domain knowledge the functional that the product under development shall implement.

When working through the experiments in the LPCXpresso Experiment Kit you will increase your knowledge in the first three areas.

Enjoy working with the LPCXpresso Experiment Kit!

4 Kit Content

In this chapter we will take a closer look at the different components included in the *LPCXpresso Experiment Kit*.

The table below contains photos and a description of all components in order to simplify identification. Note that photos are only typical in the sense that they illustrate how the components typically look like. Exact appearance can differ for the components kit that you have received. The number of components shown in a picture can also differ from delivered quantity.

Most components are specified with a Digikey or Mouser equivalent. If a component gets damaged, a new one can typically be ordered from Digikey, Mouser or any preferred component distributor. The Digikey/Mouser number is just to get the key data of the component. The actual components in the component kit might very well be of different brands.

Component	Description	Note
	Breadboard	Digikey: 438-1109-ND Mouser: 854-BB400T
	Cables, male-to- male	Prototype cables can be ordered from Embedded Artists web shop in 50 pcs packages (EA-ACC-017).
	Connectors for LPCXpresso board	There is another pair of headers that looks very similar. This pair of
	11mm long pins	connectors has longer pins. The other pair has shorter pins.
		This air of connectors shall be soldered to an LPCXpresso board to make it <i>experiment friendly</i> – make it simple to connector cables to the pins.
		There is no distributor equivalent for this component.

Tantal capacitor C1, C2, C12 22uF	This component is polarized. One of the two pins is longer than the other. This is the positive side. There is also a small plus sign printed on the components on the long pin side. AVX: TAP226K010SCS Digikey: 478-1874-ND Mouser: 581-TAP226K010SCS
Ceramic capacitor C3, C4 18pF	The printed numbers on this component is "180". This is not a polarized component. Murata: RPE5C2A180J2P1Z03B Digikey: 490-3632-ND Mouser: 81-RPE5CA180J2P1Z03B
Ceramic capacitor C5, C6, C7, C8, C9, C13 100nF	The printed numbers on this component is "106". This is not a polarized component. Kemet: C320C104K5R5TA Digikey: 399-4264-ND Mouser: 80-C320C104K5R
Ceramic capacitor C10, C11 100nF SMT	This is a surface mounted component and can only be soldered to the pcb (i.e., not used on the bread board). This is not a polarized component. Murata: GRM21BR71E104KA01L Digikey: 490-1673-1-ND Mouser: 81-GRM40X104K25L

Schottky diode D1, D2 1N5817	This component is polarized. There is a ring on one pin-side of the components (upper side in the picture). This is the cathode of the diode. The other side (bottom side) is the anode. Diodes Inc: 1N5817-T Digikey: 1N5817DICT-ND Mouser: 621-1N5817
Stand-offs H1, H2, H3, H4	These stand-offs are mounted in each corner of the pcb. AVC: BS-13S Any standard stand-off for 4mm holes will work.
Power jack J1	This component and can only be soldered to the pcb (i.e., not used on the bread board). CUI Inc: PJ-102A Digikey: CP-102A-ND
Connectors for LPCXpresso board J2	There is another pair of headers that looks very similar. This pair of connectors has shorter pins. The other pair has longer pins. This pair of connectors shall be soldered to the pcb as a socket to the LPCXpresso board. Sullins: PPTC271LFBN-RC Digikey: S7025-ND
Debug connector J3	This component and can only be soldered to the pcb (i.e., not used on the bread board). There is no distributor equivalent for this component.

RJ45, Ethernet connector J4	This component and can only be soldered to the pcb (i.e., not used on the bread board). Stewart: SI-50170-F Digikey: 380-1103-ND
Pin list, 1x3 J5, J6, J8, J12	Sullins: PEC03SAAN Digikey: S1012E-03-ND
Pin list, 2x3 J7 and J11 combined	This component and can only be soldered to the pcb (i.e., not used on the bread board). Sullins: PEC03DAAN Digikey: S2012E-03-ND
 USB-B connector J9	This component and can only be soldered to the pcb (i.e., not used on the bread board). TE Connectivity: 292304-2 Digikey: A98573-ND Mouser: 571-292304-2
USB-A connector J10	This component and can only be soldered to the pcb (i.e., not used on the bread board). TE Connectivity: 292336-1 Digikey: 292336-1-ND Mouser: 571-292336-1

socket connector for wireless module J15	This component and can only be soldered to the pcb (i.e., not used on the bread board). Sullins: NPPN101BFCN-RC Digikey: S5751-10-ND
Shrouded pin list, 2x7 J16	This component and can only be soldered to the pcb (i.e., not used on the bread board). Sullins: SBH11-PBPC-D07-ST-BK Digikey: S9170-ND
USB mini-B connector J17	This component and can only be soldered to the pcb (i.e., not used on the bread board). Hirose: UX60-MB-5ST Digikey: H2959CT-ND Mouser: 798-UX60-MB-5ST
Pin list, 1x6 J18	Sullins: PEC06SAAN Digikey: S1012E-06-ND
 LEDs LED1-LED8	This component is polarized. One of the two pins is longer than the other. This is the positive side, the anode. There is also a small cut on the side of the plastic package. This is on the short pin side, which is the negative side, the cathode.
	Any 5mm LED with V _f around 1.7V and 150mcd at 20mA current will work, for example: Digikey: 1080-1136-ND

	RGB-LED LED10	This component is polarized. There is a small cut on one side of the plastic package. In the component picture to the left, the cut is on the left side of the package. From left to right the four pins in the picture are: Red-LED cathode
		All LEDs anode (positive side) Blue-LED cathode Green-LED cathode
		Harvatek: HT-333RGBW-A Any RGB-LED with common anode and a low value of blue LED V _f (around 3.2V) will work.
FIFI	7-sigment LED, dual digit LED9	This component is polarized. Pin 1 is in the lower left corner in the picture to the left.
Ħ. Ħ.		Lite-On Inc: LTD-4608JF Digikey: 160-1536-5-ND Mouser: 859-LTD-4608JF
	LEDs LED11-LED18, SMT	This is a surface mounted component and can only be soldered to the pcb (i.e., not used on the bread board).
		This component is polarized. There are green marks on the cathode side.
		Harvatek: HT17-2102SURC Possible substitute is Kingbright: APT2012SURCK Digikey: 754-1133-1-ND Mouser: 604-APT2012SURCK
	PNP transistor, BC557B Q1, Q2, Q3	This component is polarized. One side of the plastic package is flat and the other side is rounded. When mounting this component make sure it is turned correctly.
		ON Semiconductor: BC557BRL1G Digikey: BC557BRL1GOSCT-ND Mouser: 863-BC557BRL1G

	Resistor, 15 Kohm, 7 pcs R1, R3, R35, R36, R41, R42, R59	Color: Brown, Green, Black, Red This is not a polarized component. Yageo: MFR-25FBF-52-15K0 Digikey: 15.0KXBK-ND
151C 250 600 600 600 600 600 600	Resistor, 0 ohm, 1 pcs R2	Color: Black This is not a polarized component. Yageo: ZOR-25-B-52-0R Digikey: 0.0QBK-ND
	Resistor, 330 ohm, 30 pcs R4, R5, R6, R8, R9, R10, R11, R12, R13, R14, R15, R16, R17, R18, R19, R21, R22, R23, R25, R29, R30, R31, R32, R33, R34, R37, R38, R62, R63, R64	Color: Orange, Orange, Black, Black This is not a polarized component. Yageo: CFR-25JB-52-330R Digikey: 330QBK-ND
	Trimming potentiometer, 22 Kohm, 2 pcs R7, R20	10Kohm equivalent from Bourns Inc.: 3352E-1-103LF Digikey: 3352E-103LF-ND

Photo resistor, 1 pcs R24	This is not a polarized component. Advanced Photonix: PDV-P9002-1 Digikey: PDV-P9002-1-ND
Resistor, 220 ohm, 2 pcs R27, R28	Color: Red, Red, Black, Black This is not a polarized component. Yageo: FMP100JR-52-220R Digikey: 220WCT-ND
Resistor, 1.5 Kohm, 8 pcs R26, R39, R40, R60, R61, R65, R66, R67	Color: Brown, Green, Black, Brown This is not a polarized component. Yageo: FMP100JR-52-1K5 Digikey: 1.5KWCT-ND
Resistor, 2 Kohm, 16 pcs R43, R44, R45, R46, R47, R48, R49, R50, R51, R52, R53, R54, R55, R56, R57, R58	This is a surface mounted component and can only be soldered to the pcb (i.e., not used on the bread board). This is not a polarized component. Panasonic: ERJ-6ENF2001V Digikey: P2.00KCCT-ND

Piezo buzzer, 1 pcs SP1	This component is polarized. One pin is longer than the other. The longer pin is the positive side. The top label also indicates this side with a small plus sign. CUI Inc.: CEP-2242 Digikey: 102-1115-ND
Pushbuttons, 5 pcs SW1-SW5	This component and can only be soldered to the pcb (i.e., not used on the bread board). The reason for this is that the pins are too short to get reliable connection on the bread board. There are two other special switches in the component kit that are suitable for bread board usage. Omron: B3F-1000 Digikey: SW400-ND Mouser: 653-B3F-1000
Pushbuttons for breadboard, 2 pcs	These switches are for breadboard usage. Panasonic: EVQ-11L05R Digikey: P8079SCT-ND Mouser: 667-EVQ-11L05R
Rotary encoder, 1 pcs SW6	This component and can only be soldered to the pcb (i.e., not used on the bread board). Below is without center switch. Panasonic: EVE-GA1F1724B Digikey: P10859-ND Mouser: 667-EVE-GA1F1724B

	Voltage regulator, MCP1700-330, 1 pcs U1	This component is polarized. One side of the plastic package is flat and the other side is rounded. When mounting this component, make sure it is turned correctly. Microchip: MCP1700-3302E/TO Digikey: MCP1700-3302E/TO-ND Mouser: 579-MCP1700-3302E/TO
- • •	Microcontroller, LPC1114FN28, 1 pcs U2	This component is polarized. There is a cut in one end of the plastic package, on the short side. This indicates where pin 1 is located. When mounting this component make sure it is turned correctly. NXP: LPC1114FN28/102
		Digikey: LPC1114FN28/102,12-ND Mouser: 771-LPC1114FN28/1021
	Headers for U2	This pair of connector headers can (optionally) be soldered to the pcb as a socket for U2. By adding these connectors/headers it is possible to either mount the LPCXpresso board (in J2 headers) or mount U2 in these headers. If J2 headers are mounted but these headers are not, then it is not possible to mount U2.
		Sullins: PPTC141LFBN-RC Digikey: S7012-ND
	Shift register, 74HC595, 1 pcs U3	This component is polarized. There is a cut in one end of the plastic package, on the short side. This indicates where pin 1 is located – lower left side in the picture to the left. When mounting this component make sure it is turned correctly. NXP: 74HC595N Digikey: 568-1484-5-ND Mouser: 771-74HC595N

Temperature sensor, MCP9701, 1 pcs U4	This component is polarized. One side of the plastic package is flat and the other side is rounded. When mounting this component make sure it is turned correctly. Microchip: MCP9701-E/TO Digikey: MCP9701-E/TO-ND Mouser: 579-MCP9701-E/TO
SPI flash, 25LC080, 1 pcs U5	This component is polarized. There is a cut in one end of the plastic package, on the short side. This indicates where pin 1 is located. When mounting this component, make sure it is turned correctly. Microchip: 25LC080D-I/P Digikey: 25LC080D-I/P-ND Mouser: 579-25LC080D-I/P
Temperature sensor, LM75, 1 pcs U6	This is a surface mounted component and can only be soldered to the pcb (i.e., not used on the bread board). This component is polarized. When rotating the components so that the printed text on the package can be read, pin 1 is in the lower left side on the package. When mounting this component make sure it is turned correctly. NXP: LM75BD Digikey: 568-4688-1-ND Mouser: 771-LM75BD118

	I2C port expander, PCA9532, 1 pcs U7	This is a surface mounted component and can only be soldered to the pcb (i.e., not used on the bread board).
		This component is polarized. When rotating the components so that the printed text on the package can be read, pin 1 is in the lower left side on the package. When mounting this component make sure it is turned correctly.
		NXP: PCA9532D Digikey: 568-1039-5-ND Mouser: 771-PCA9532D-T
	12MHz HC49	This is not a polarized component.
	crystal, 1 pcs Y1	CTS-Freq. Controls: ATS120B Digikey: CTX904-ND

5 Powering Options

There are a couple of different options how to powering the experiments. Read through all different options to determine which powering option fits your needs.

- The simplest and most common way is to let the LPCXpresso board generate the +3.3V supply that is needed. This voltage is available on pin 29 on the LPCXpresso expansion connector (see schematic for details). R2 should not be mounted in this case.
 - The LPCXpresso board can supply up to about 100 mA on the +3.3V supply. Note that by turning on all LEDs and activating all features on the board it is possible to consume more than 100 mA.
 - Note that the voltage is not exactly 3.3V, but a Schottky diode forward voltage drop less, so around 3.15V.
- In case the LPCXpresso board is not powered via its USB connector an external +5V DC supply is needed. Connect the external supply to J1 or J17 (as described below).
 - If the internal +3.3V voltage regulator on the LPCXpresso board is used, R2 shall not be mounted. Else R2 shall be mounted (and U1 is the +3.3V regulator in use).
- If current consumption on the +3.3V supply is higher that the LPCXpresso board can provide an external +5V DC supply is needed. This is typically true when working with wireless/RF modules and/or with the USB Host interface (J10 connector). When working with servo motors an external +5V supply is absolutely needed.
 - An external +5V DC supply can connect to J1, which is a 2.1mm power jack with
 positive center pin. Note that there is no overvoltage protection in the design. Make
 sure that the connected power supply does not supply more than +5V DC. The
 current capability of the external +5V DC supply should be in the region of 1-2
 Ampere.
 - Connector J17 (mini-B USB connector on the back side of the pcb) can also be used to supply an external +5V DC supply via the USB Host port on a PC/laptop/USB hub.
- When using the LPC1114 in DIL28 package an external +5V DC supply is needed. Feed the +5V via J1 or J17 (as described above) and mount R2 (in order to let U1 be the +3.3V regulator in use).
- When using an mbed module, this module can generate the needed +3.3V supply (supply comes from its own USB connector). R2 should not be mounted in this case.
 - The mbed module can supply much more current on the +3.3V supply than an LPCXpresso board can.
 - In case the mbed module is not powered via its USB connector, it is possible to power it with an external +5V DC supply via connector J1 or J17 (as described above).

Below is a short list, summarizing the options:

Mbed module: do not mount R2, power via mbed module USB connector or external +5V supply.

LPC1114 in DIL28: mount R2, power via external +5V supply.

Using servo interface, USB Host interface and/or RF module: power via external +5V supply.

LPCXpresso board: do not mount R2, power via mini-B USB interface or external +5V supply.